

November 2013

FFPF30UP20S 30 A, 200 V, Ultrafast Diode

Features

- Ultrafast Recovery t_{rr} = 50 ns (@ I_F = 30 A)
- Max Forward Voltage, V_F = 1.15 V (@ T_C = 25°C)
- Reverse Voltage, V_{RRM} = 200 V
- · Avalanche Energy Rated
- · RoHS Compliant

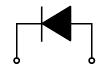
Applications

- · Output Rectifiers
- · SMPS, Power Switching Circuirs
- · Free-Wheeling Diode for Motor Application

Description

The FFPF30UP20S is a ultrafast diode with low forward voltage drop. This device is intended for use as freewheeling and clamping diodes in a variety of switching power supplies and other power switching applications. It is specially suited for use in switching power supplies and industrial application.





1. Cathode 2. Anode

Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter	Rating	Unit
V _{RRM}	Peak Repetitive Reverse Voltage	200	V
V_{RWM}	Working Peak Reverse Voltage	200	V
V _R	DC Blocking Voltage	200	V
I _{F(AV)}	Average Rectified Forward Current @ T _C = 102°C	30	Α
I _{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	300	А
T _J , T _{STG}	Operating and Storage Temperature Range	-65 to +150	οС

Thermal Characteristics

Symbol	Parameter	Max.	Unit
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	3.0	°C/W

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FFPF30UP20STU	FFPF30UP20S	TO-220F-2L	Tube	N/A	N/A	50

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max.	Unit
V _F *	I _F = 30 A I _F = 30 A	T _C = 25 °C T _C = 100 °C		-	1.15 1.0	V V
I _{R *}	V _R = 200 V V _R = 200 V	T _C = 25 °C T _C = 100 °C	-	-	100 500	μ Α μ Α
t _{rr}	$I_F = 1 \text{ A, } di_F/dt = 100 \text{ A/}\mu\text{s, V}_R = 30 \text{ V}$ $I_F = 30 \text{ A, } di_F/dt = 200 \text{ A/}\mu\text{s, V}_R = 130 \text{ V}$	T _C = 25 °C T _C = 25 °C		-	40 50	ns ns
t _a t _b Q _{rr}	I _F =30 A, di _F /dt = 200 A/μs, V _R = 130 V	$T_C = 25 ^{\circ}C$ $T_C = 25 ^{\circ}C$ $T_C = 25 ^{\circ}C$	- - -	22 14 67	- - -	ns ns nC
W _{AVL}	Avalanche Energy (L = 40 mH)		20	-	-	mJ

^{*} Pulse Test: Pulse Width=300µs, Duty Cycle=2%

Test Circuit and Waveforms

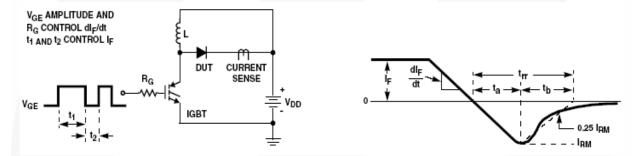


Figure 1. Diode Reverse Recovery Test Circuit & Waveform

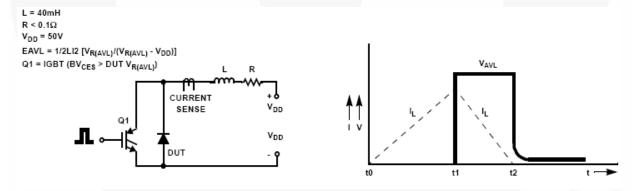


Figure 2. Unclamped Inductive Switching Test Circuit & Waveform

Typical Performance Characteristics

Figure 3. Typical Forward Voltage Drop

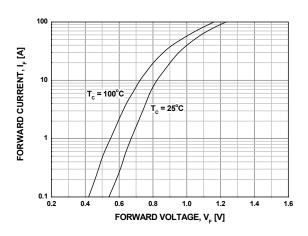


Figure 4. Typical Reverse Current

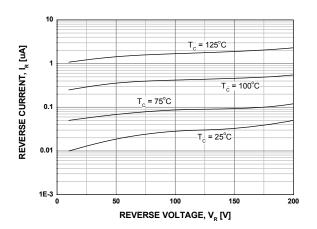


Figure 5. Typical Junction Capacitance

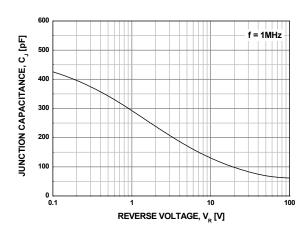


Figure 6. Typical Reverse Recovery Time

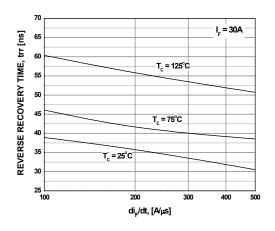


Figure 7. Typical Reverse Recovery Current

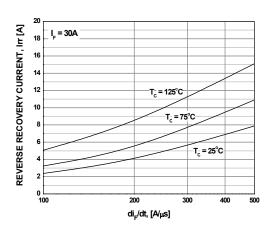
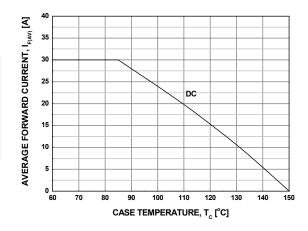


Figure 8. Forward Current Deration Curve



Mechanical Dimensions

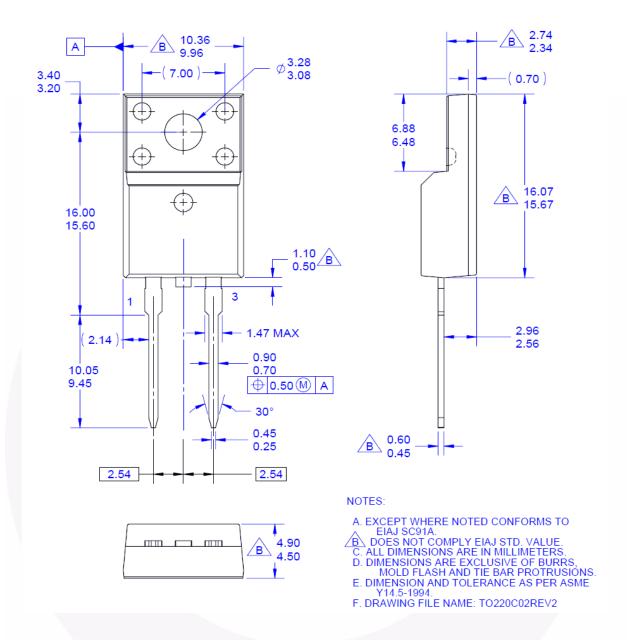


Figure 9. TO-220F 2L - 2LD; TO220; MOLDED; FULL PACK

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